



NVIDIA MODULUS: AN AI FRAMEWORK FOR PHYSICS ML



MODULUS TALKS IN GTC NOV. '21

Physics-informed Neural Networks for Wave Propagation Using NVIDIA SimNet

[A31302]

Toward Developing High Reynolds Number, Compressible, Reacting Flows in Modulus

[A31094]

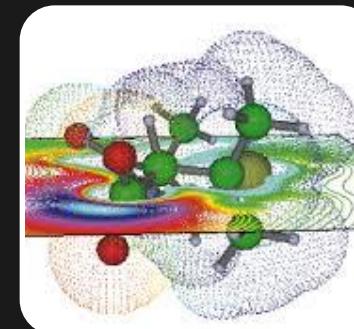
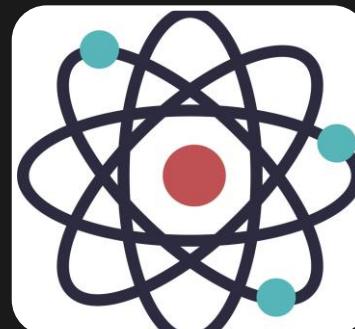
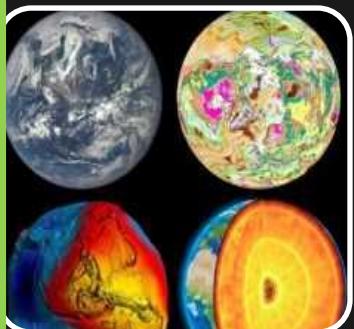
Uncertainty Quantification for Transport in Porous Media Using Parameterized Physics Informed Neural Networks

[A31281]

Accelerate HPC simulations at scale with Physics-informed Neural Networks (PINNs) and NVIDIA GPUs on AWS

[A31724]

AI POWERED SCIENCE & ENGINEERING DOMAINS



Engineering Physics

Solid & Fluid Mechanics,
Electromagnetics,
Thermal, Acoustics,
Optics, Electrical,
Multi-body Dynamics,
Design Materials,
Systems

Earth Sciences

Climate Modeling,
Weather Modeling,
Ocean Modeling,
Seismic Interpretation

Life Sciences

Genomics,
Proteomics

Computational Physics

Particle Science,
Astrophysics

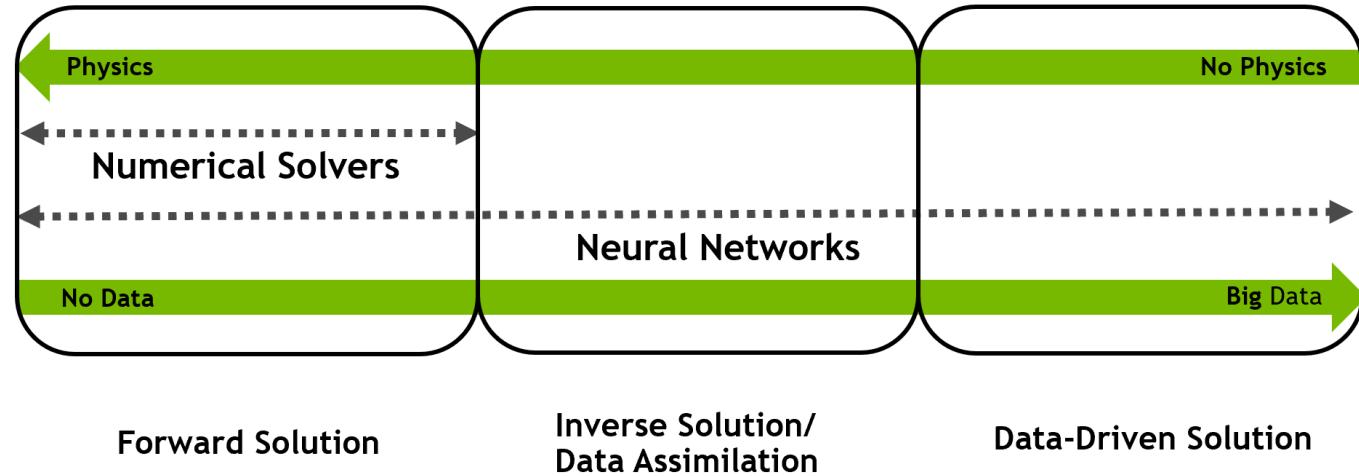
Computational Chemistry

Quantum Chemistry,
Molecular Dynamics

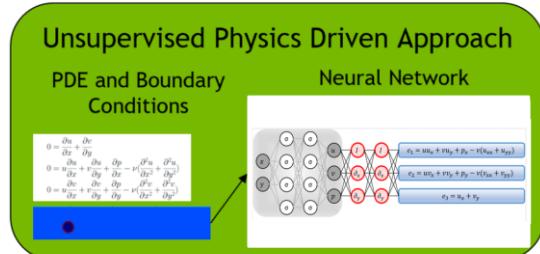
Process/Product Design,
Manufacturing, Testing,
In-Service

AI IN COMPUTATIONAL SCIENCES

Primary Driver: Data vs. Physics

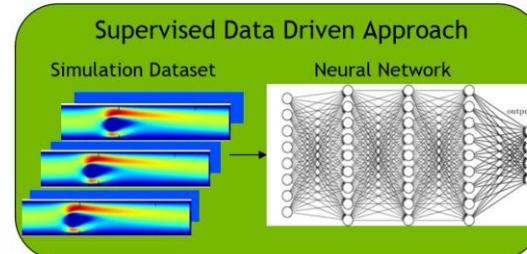


A Physics Driven Neural Network solver does NOT require training data



m*N layers (for mth order PDE)

A Data Driven Neural Network requires training data



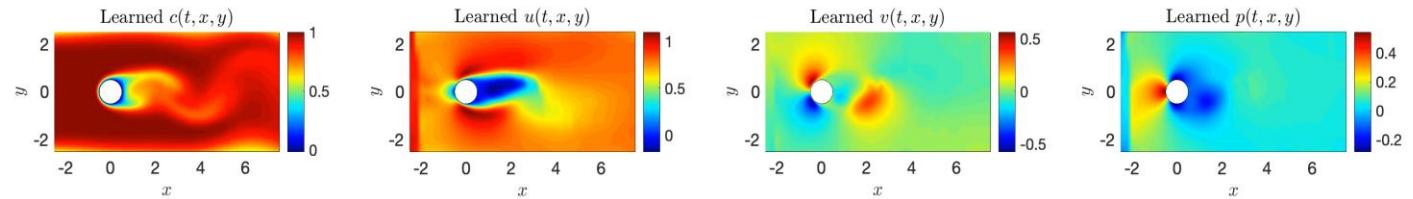
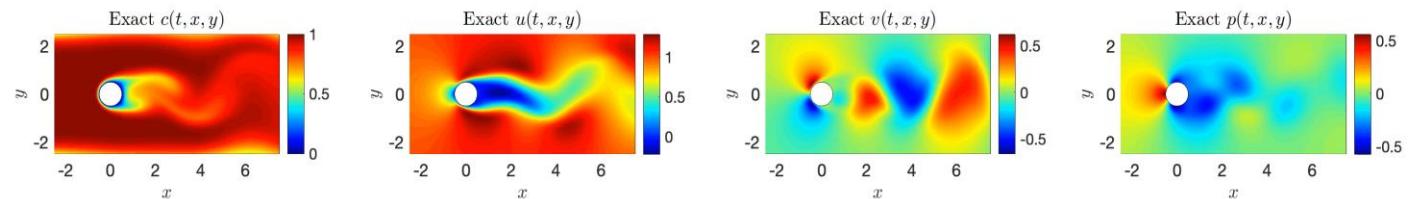
N layers

Data Driven Neural Networks

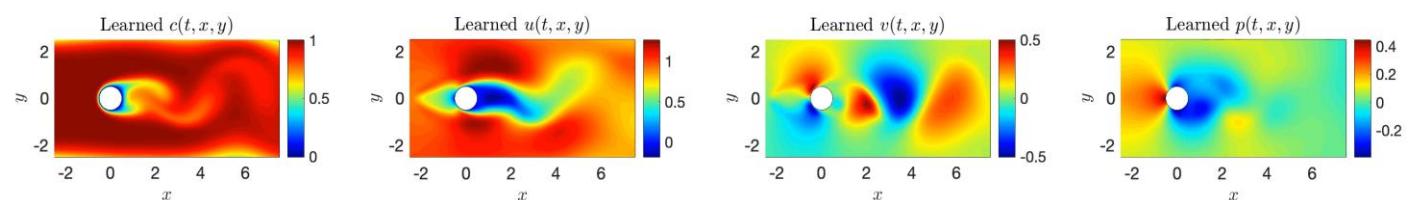
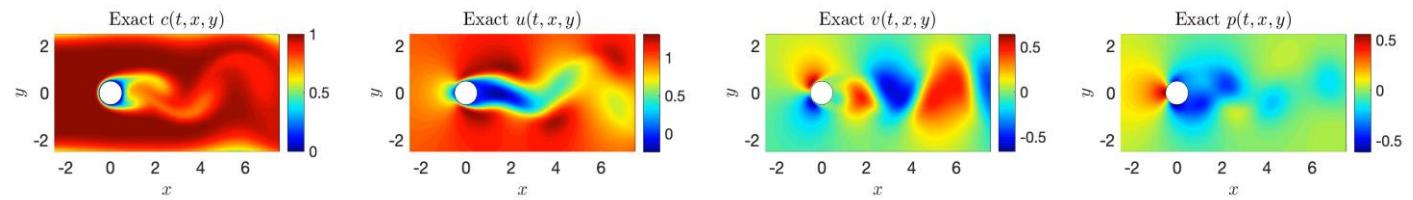


TRANSIENT: EXTERNAL FLOW PAST A 2D CYLINDER

CFD Simulation of an External Flow over a Cylinder

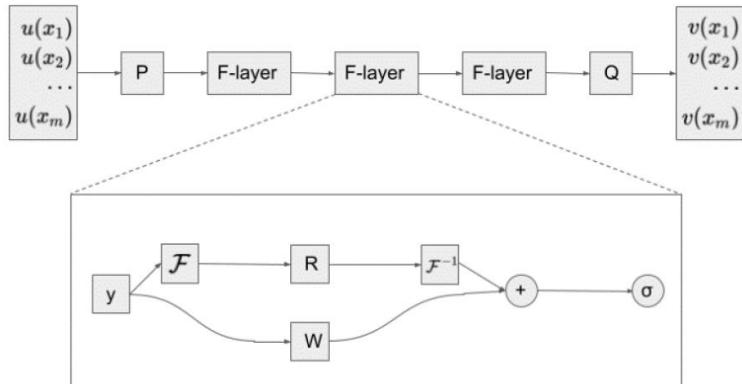


Corrected CFD Simulation Results (Ground Truth)



AUTOMATED DETECTION OF SI HOTSPOTS

Nvidia GeForce Boards



Fourier Neural Operator

1 Trace A

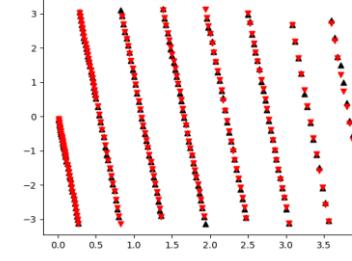
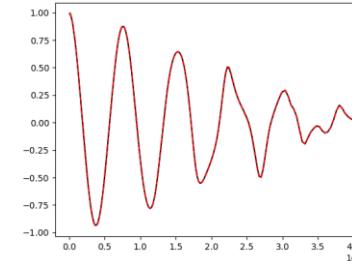
3 Trace B

Return loss (RL) → launch at 1; observation at 1

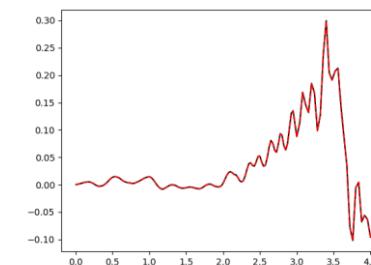
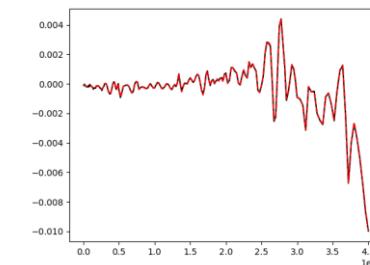
Insertion loss (IL) → launch at 1; observation at 2

Near end crosstalk (NEXT) → launch at 1; observation at 3

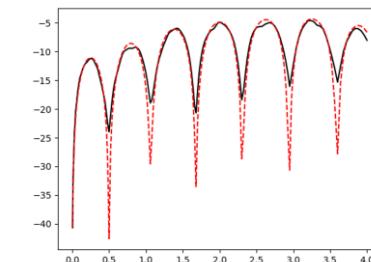
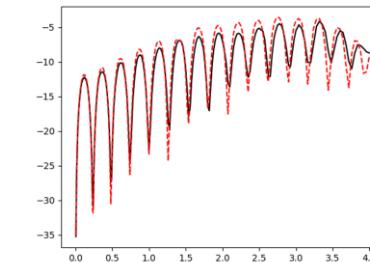
Far end crosstalk (FEXT) → launch at 1; observation at 4



Insertion Loss



Cross-Talk



Return Loss

DATA DRIVEN METHODS

Strengths
Measured/observed data along with Physics laws provides the most accurate representation of state
Data enables discovering of trends even when Physics is not known or too complex to model
Weaknesses
No Physics awareness
If measured/observed data is not available then time-consuming simulations are needed to generate the data.
Accuracy is dependent on the simulation code and user expertise
Lower Generalizability
Modeling complex 3D geometries/curved surfaces may be error prone

Modulus



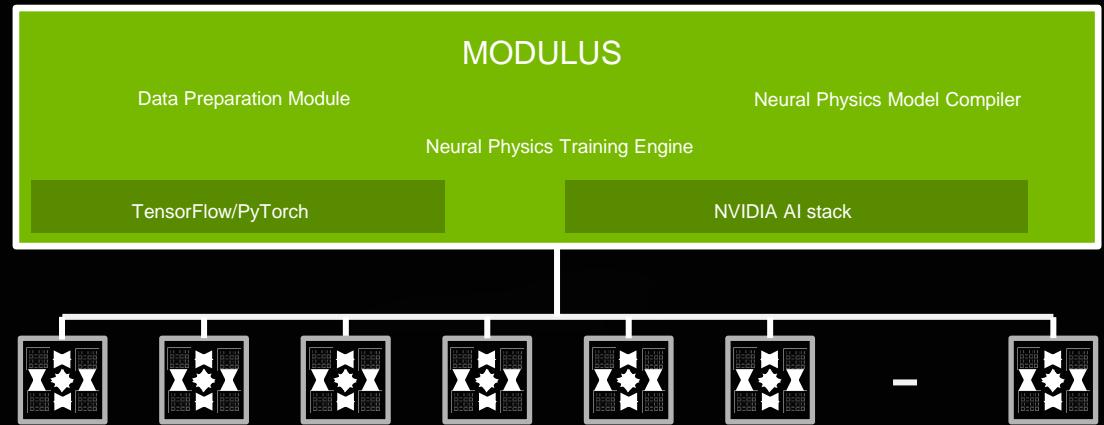
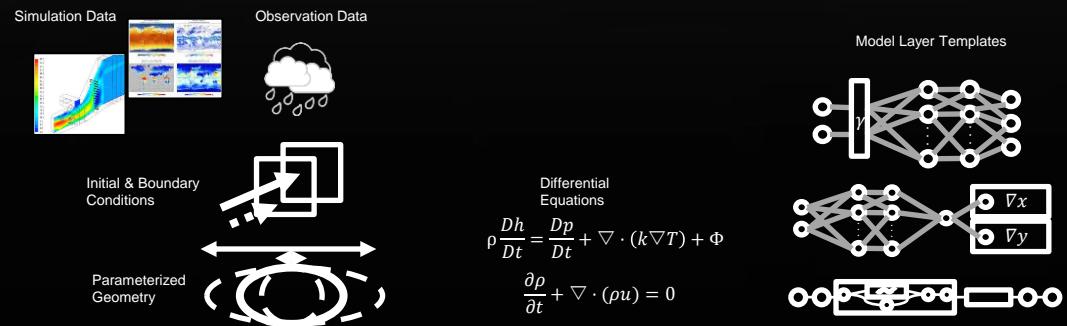
WHAT IS MODULUS?

NVIDIA MODULUS

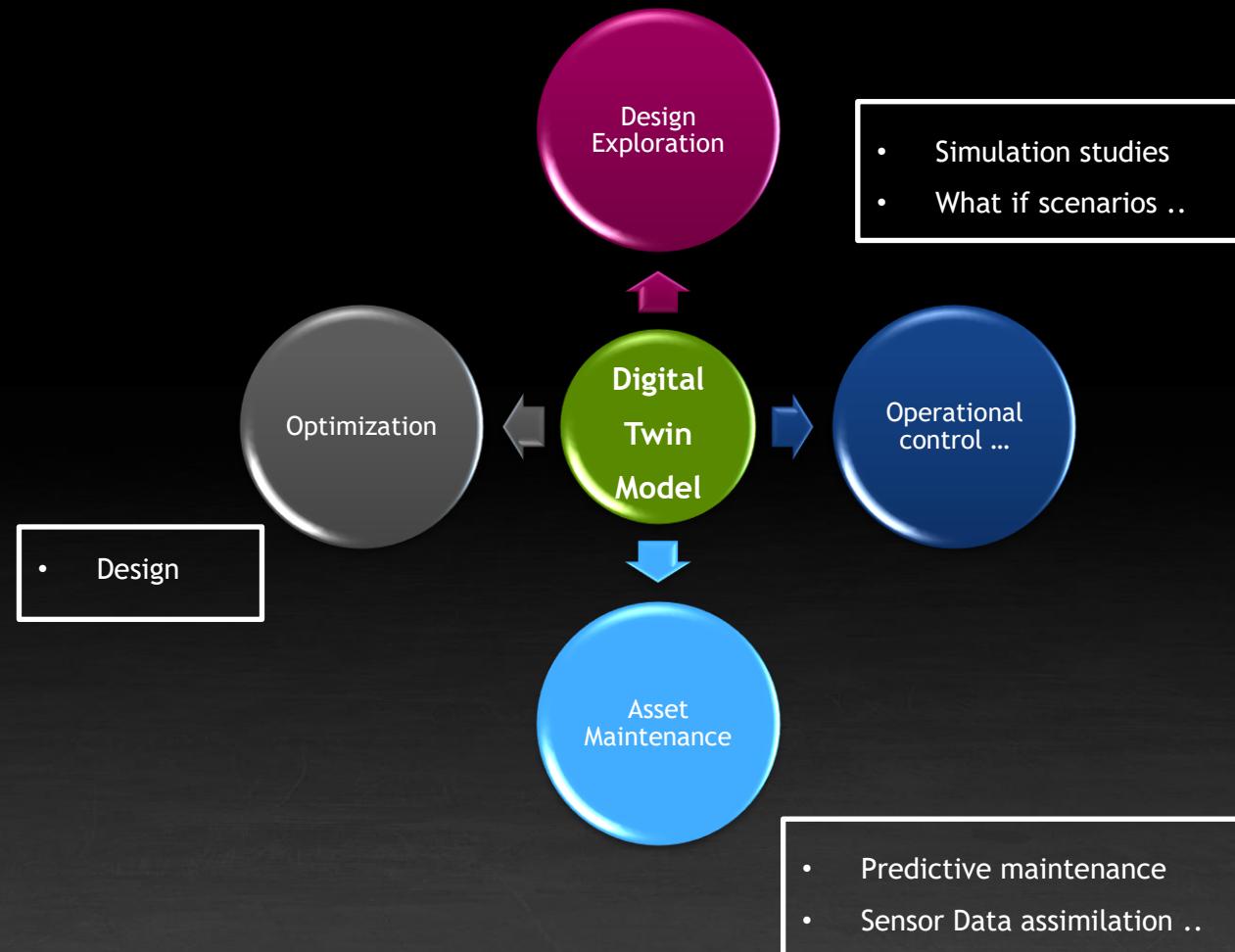
Framework for Developing Physics ML Models -
AI framework for Science & Engineering problems

Use simulation and observation data and
governing physics equations to generate a robust
Digital Twin model

What its not? Not a Solver, Not a Simulation
platform



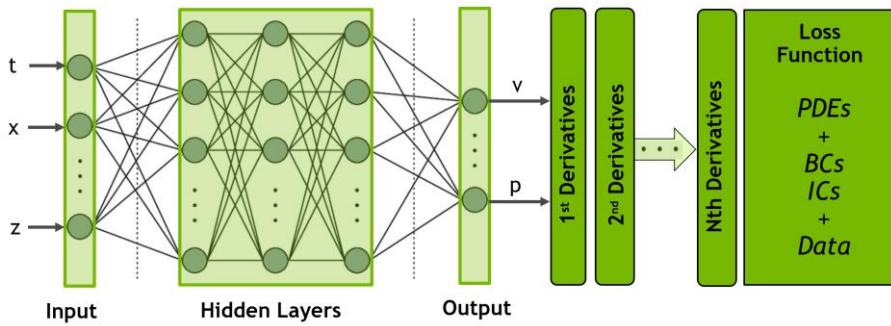
WHY MODULUS?



MODULUS FUNCTIONALITY

Physics Based Neural Network: Architectures & Features

Architectures:



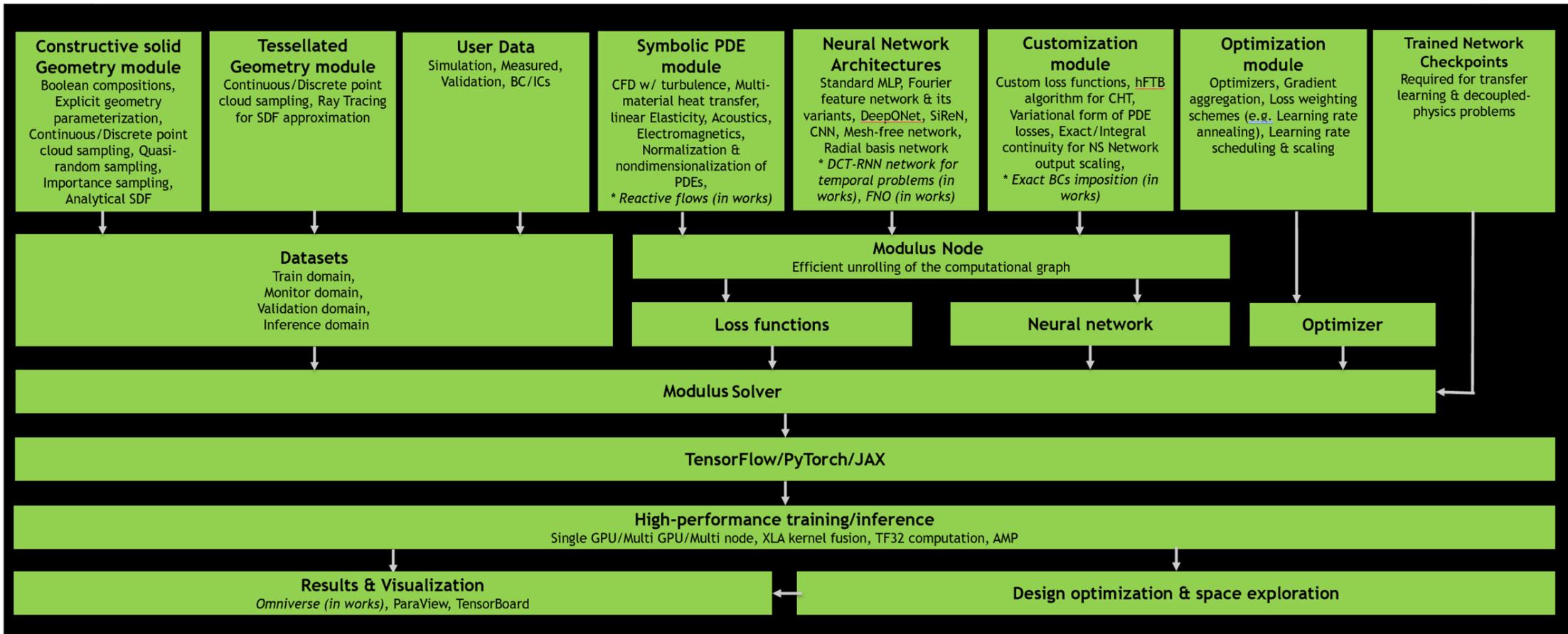
- Fully Connected (FC)
- Fourier Features (FN) - Axis, Partial, Full or Random Spectrum, Positional & Gaussian Encodings, Multi-Scale
- Sinusoidal Representation (SiReNs)
- Modified Fourier Features (mFN)
- Deep Galerkin Method (DGM)
- Modified Highway Networks
- Multiplicative Filter Networks

Features:

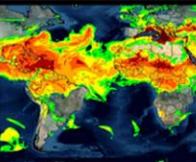
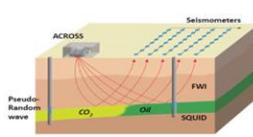
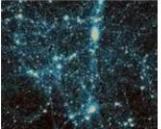
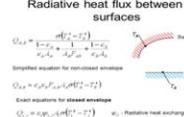
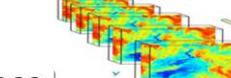
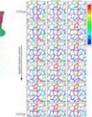
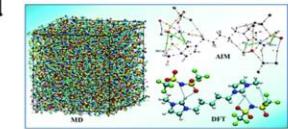
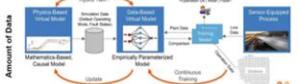
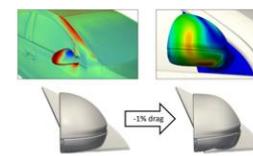
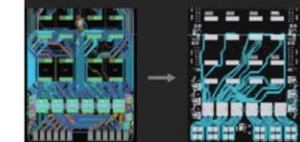
- CFD, Thermal, Electromagnetics, Solids, Acoustics
- Geometry Modules: STL or Parametrized CSG
- Differential & Variational treatment of PDEs
- Time stepping schemes for Transient Problems
- Homoscedastic task uncertainty quant. for loss wt.
- hFTB algorithm for conjugate heat transfer problems
- Global & Local Learning Rate Annealing
- Global Activation Functions
- Halton Sequences for Low-Discrepancy Point Cloud
- SDF weighting of Losses
- Integral & Exact Continuity (Mass Balance)
- Quasi-Random/Continuous Sampling of Point Cloud
- Importance Sampling
- Gradient Aggregation
- Transfer Learning
- Polynomial Chaos Expansion
- Performance: XLA, Multi-GPU/Node Scaling, AMP, TF32

MODULUS CODE FLOW

<http://developer.nvidia.com/Modulus>



AI IN SCIENCE & ENGINEERING

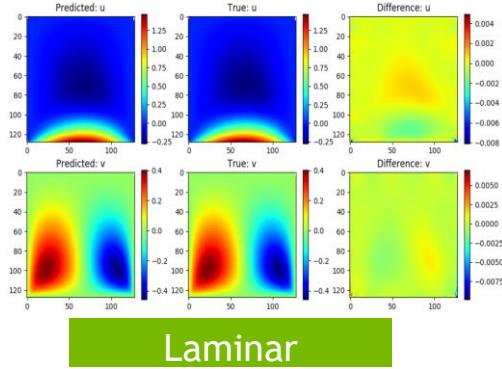
<h3>Inverse & Data Assimilation Problems</h3>  <p>Climate</p>  <p>Medical Imaging</p>  <p>Oil & Gas</p>  <p>High Energy/ Nuclear Physics</p>				<h3>Improved Physics & Predictions</h3> <p>Radiative heat flux between two surfaces</p> $Q_{A,B} = \frac{\sigma(T_A^4 - T_B^4)}{k_e A_e + k_i A_i + \epsilon_{AB} A_e A_i}$ <p>Simplified equation for non-enclosed envelope</p> $Q_{A,B} = \epsilon_{AB} F_{AB} (T_A^4 - T_B^4)$ <p>Exact equation for closed envelope</p> $Q_{A,B} = \epsilon_{AB} F_{AB} (T_A^4 - T_B^4) - \epsilon_{AB} F_{AB} \left(\frac{1}{\epsilon_{AB}} - 1 \right) \sigma T_A^3 T_B^3$ <p>ϵ_{AB} = Radiative heat exchange factor $\epsilon_{AB} = 1.2 \dots 1.6$</p>  <p>Radiation</p>  <p>Turbulence</p>  <p>Micro-mechanical Material Model</p>  <p>Molecular Dynamics</p>			
<h3>Real Time Simulations</h3>  <p>Digital Twin</p>  <p>Autonomous Ride & Handling</p>  <p>Robotics</p>  <p>Games</p>				<h3>Digital Design & Manufacturing</h3>  <p>Heat Sink</p>  <p>Aerodynamics</p>  <p>Vias on a PCB</p>			

Physics & Data - No Traditional Solver

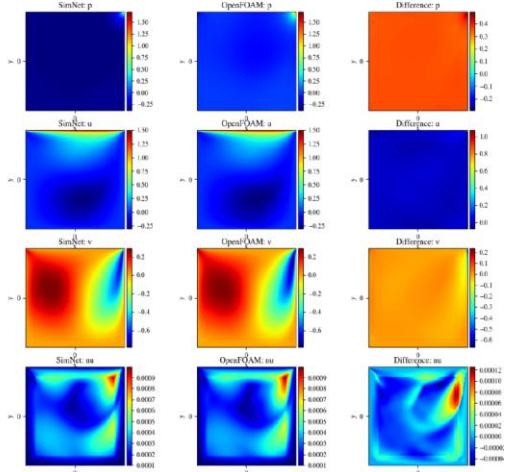
Physics - Traditional Solver (Speed is a limitation)

MODULUS FRAMEWORK - VERIFICATION

CFD

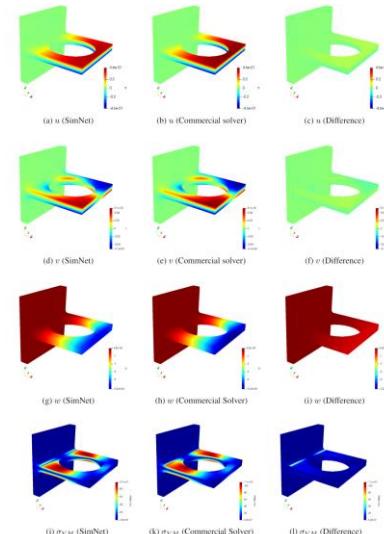


Laminar



Turbulent

Solid Mechanics

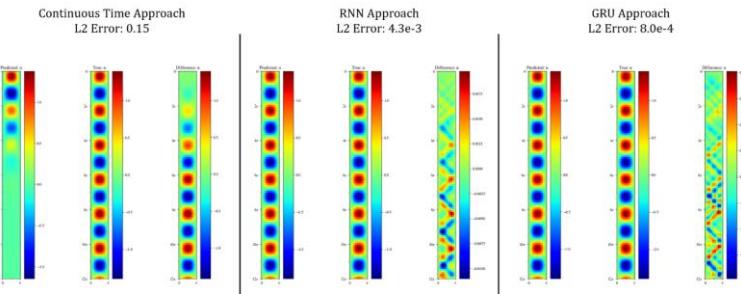


$$\text{Equilibrium: } \sigma_{ji,j} + f_i = 0,$$

$$\text{Stress-Strain: } \sigma_{ij} = \lambda \epsilon_{kk} \delta_{ij} + 2\mu \epsilon_{ij},$$

$$\text{Strain-Displacement: } \epsilon_{ij} = \frac{1}{2} (u_{i,j} + u_{j,i}).$$

Acoustics



$$u_{tt} = c^2 u_{xx}$$

$$u(0, t) = 0,$$

$$u(\pi, t) = 0,$$

$$u(x, 0) = \sin(x),$$

$$u_t(x, 0) = \sin(x).$$

MODULUS FRAMEWORK - VERIFICATION

Electromagnetics

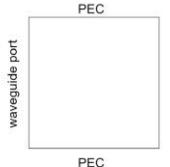


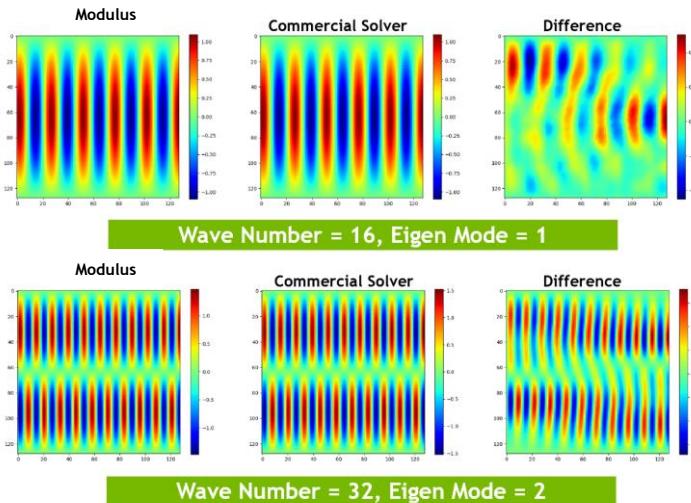
Figure 42: Domain of 2D waveguide

In this example we will solve this waveguide problem by transverse-magnetic (TM_z) mode, so that our unknown variable is $E_z(x, y)$. The governing equation in Ω is

$$\Delta E_z(x, y) + k^2 E_z(x, y) = 0,$$

where k is the wavenumber. Notice in 2D scalar case, the PEC and ABC will be simplified in the following form, respectively:

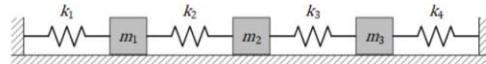
$$E_z(x, y) = 0 \text{ on top and bottom boundaries}, \quad \frac{\partial E_z}{\partial y} = 0 \text{ on right boundary}.$$



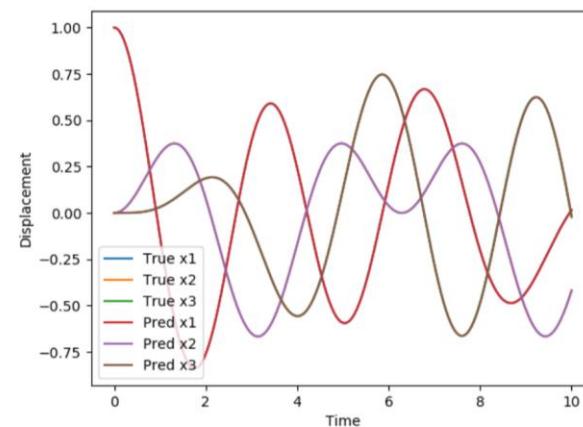
Vibrations

$$\begin{aligned} m_1 x_1''(t) &= -k_1 x_1(t) + k_2(x_2(t) - x_1(t)), \\ m_2 x_2''(t) &= -k_2(x_2(t) - x_1(t)) + k_3(x_3(t) - x_2(t)), \\ m_3 x_3''(t) &= -k_3(x_3(t) - x_2(t)) - k_4 x_3(t). \end{aligned}$$

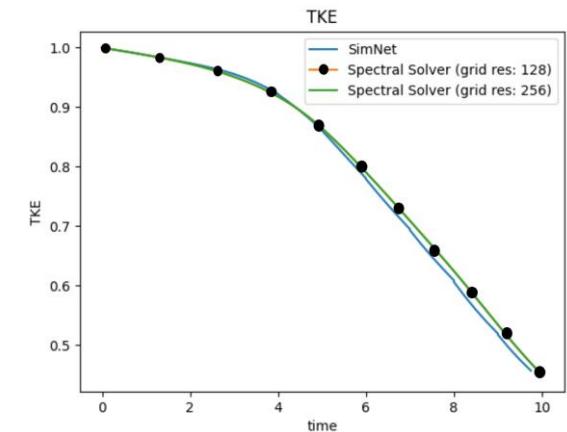
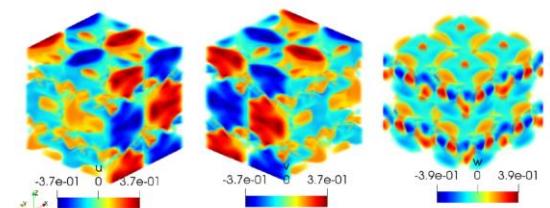
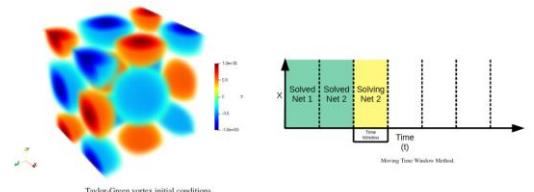
$$\begin{aligned} [m_1, m_2, m_3] &= [1, 1, 1], \\ [k_1, k_2, k_3, k_4] &= [2, 1, 1, 2], \\ [x_1(0), x_2(0), x_3(0)] &= [1, 0, 0], \\ [x_1'(0), x_2'(0), x_3'(0)] &= [0, 0, 0]. \end{aligned}$$



Three masses connected by four springs on a friction-less surface



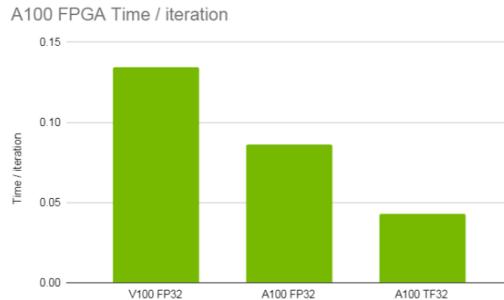
Turbulence



Taylor-Green Trubulent kinetic energy decay.

MODULUS FRAMEWORK - PERFORMANCE

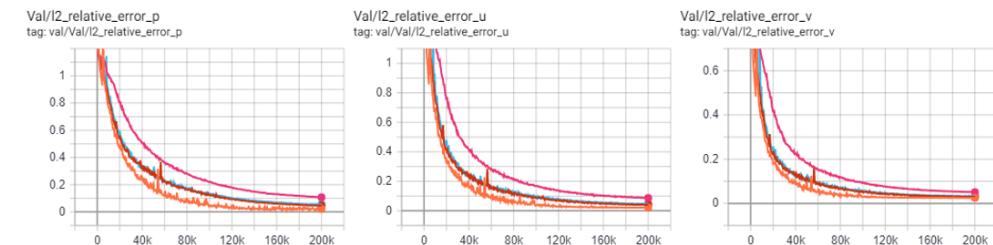
SINGLE GPU: Tensor Core Speed-up for PDEs



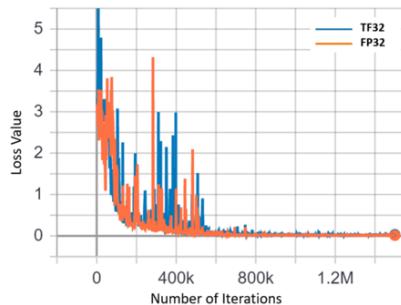
(a) Time per iteration



(b) Speed-up



Case Description	P_{drop} (Pa)	Compute Time (hrs)
Fully Connected Networks with FP32	29.24	86.9
Fully Connected Networks with TF32	29.13	39.5



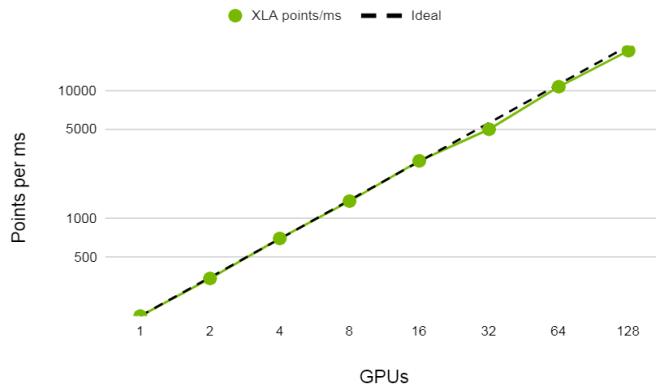
Second-order formulation	100 mins
First-order formulation	68 mins
First-order formulation + AMP	53 mins

A100 FP32 vs. TF32: Results, Compute Time, Loss

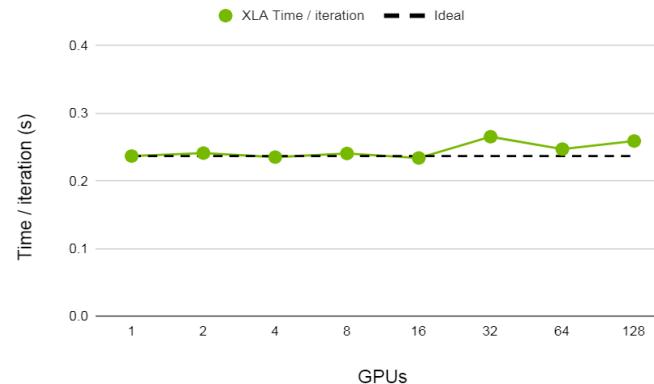
AMP

MODULUS FRAMEWORK - PERFORMANCE

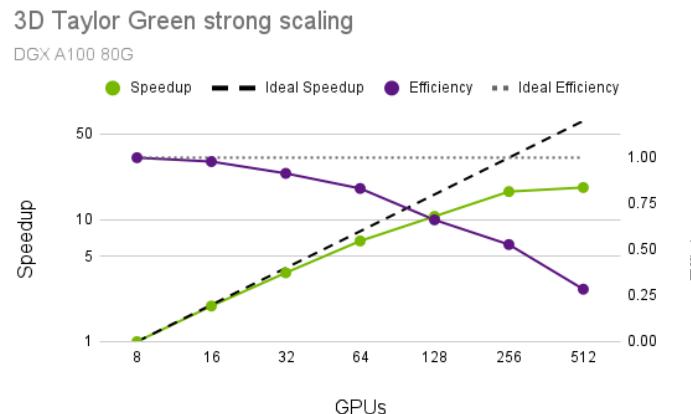
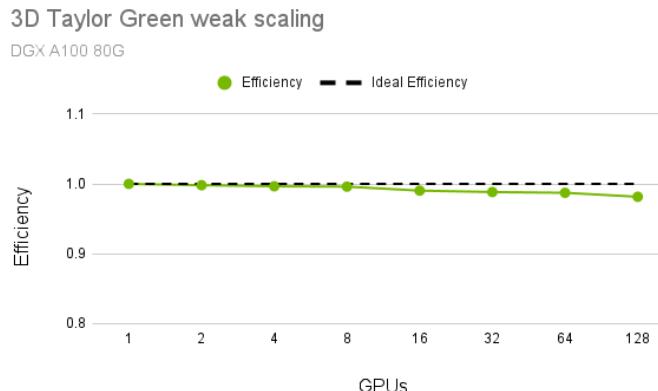
MULTI-GPU/NODE Scalability



(a) Points per ms



(b) Time per iteration



Digital Twins



DIGITAL TWIN OF AIRCRAFT CABIN PANELS

University of Central Florida (Prof. Felipe Vianna)

<https://www.phmsociety2020.com/corporate-sponsors/nvidia>

Use case (synthetic data):

- Monitoring fatigue crack growth on the corner of a window (AI 2024)
- Fleet of 300 aircraft
- 5 flights per day
- 3 to 5 years of operation

Modulus:

- PINN model for stress as a function of pressure differential
- Reduced-order model:
 - Linear elastic analysis
 - Simply supported sides and far-field hoop stresses defining boundary conditions

PINN-CDM

- Perform damage accumulation
- Adjust local stresses

Crack growth:

$$\frac{da}{dN} = C\Delta K^m \text{ and } \Delta K = F\Delta S\sqrt{\pi a}$$

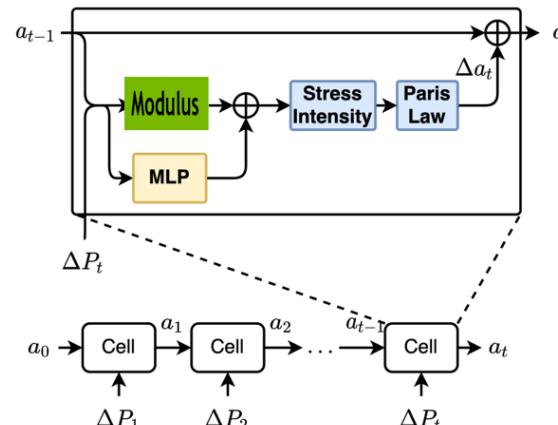
F = 1.122 (assumed)

F = f(a) (reality)



$$\sigma_{HOOP} = \frac{\Delta P \times d}{2t}$$

- d : external diameter
- t : thickness
- ΔP : pressure differential (function of altitude)



Short

Max Alt: 33000 ft
(20 min)



Medium

Max Alt: 40000 ft
(60 min)



Long

Max Alt: 40000 ft
(120 min)

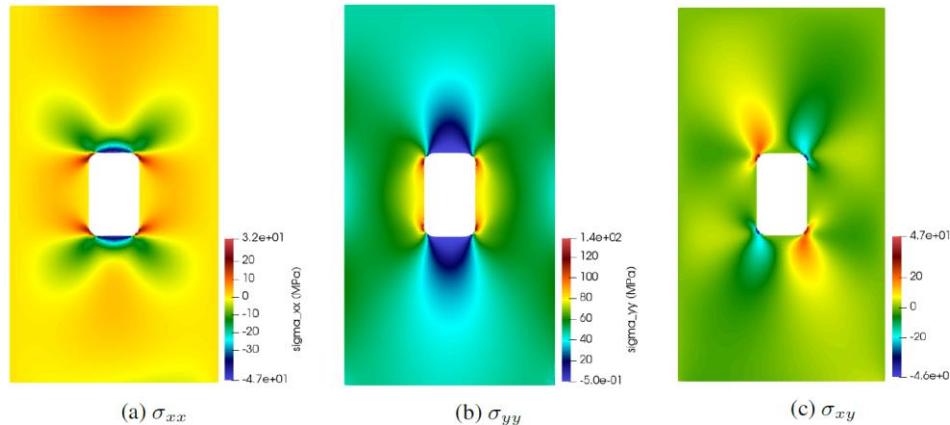


DIGITAL TWIN OF AIRCRAFT CABIN PANELS

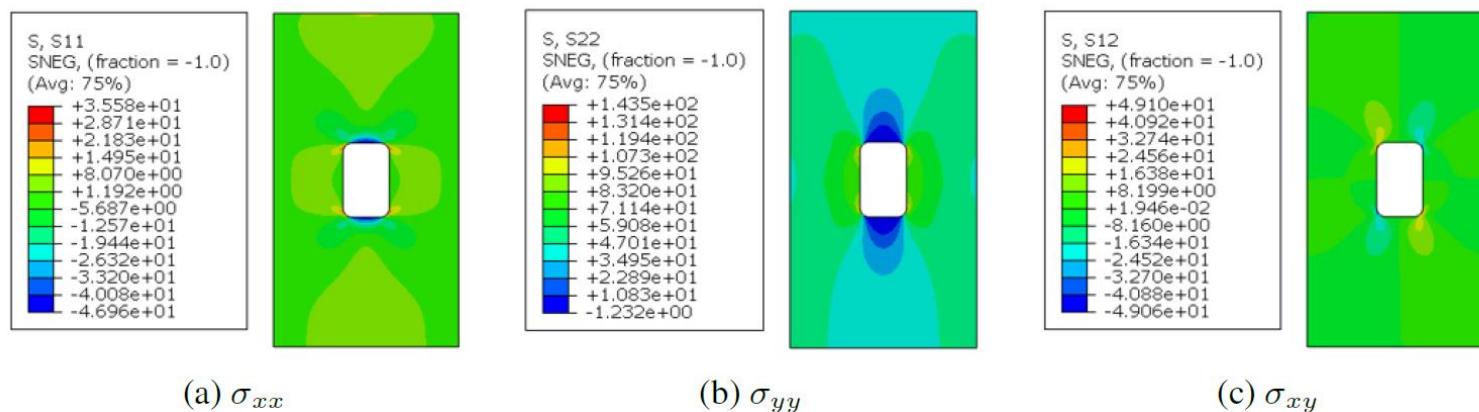
University of Central Florida (Prof. Felipe Vianna)

<https://www.phmsociety2020.com/corporate-sponsors/nvidia>

Modulus

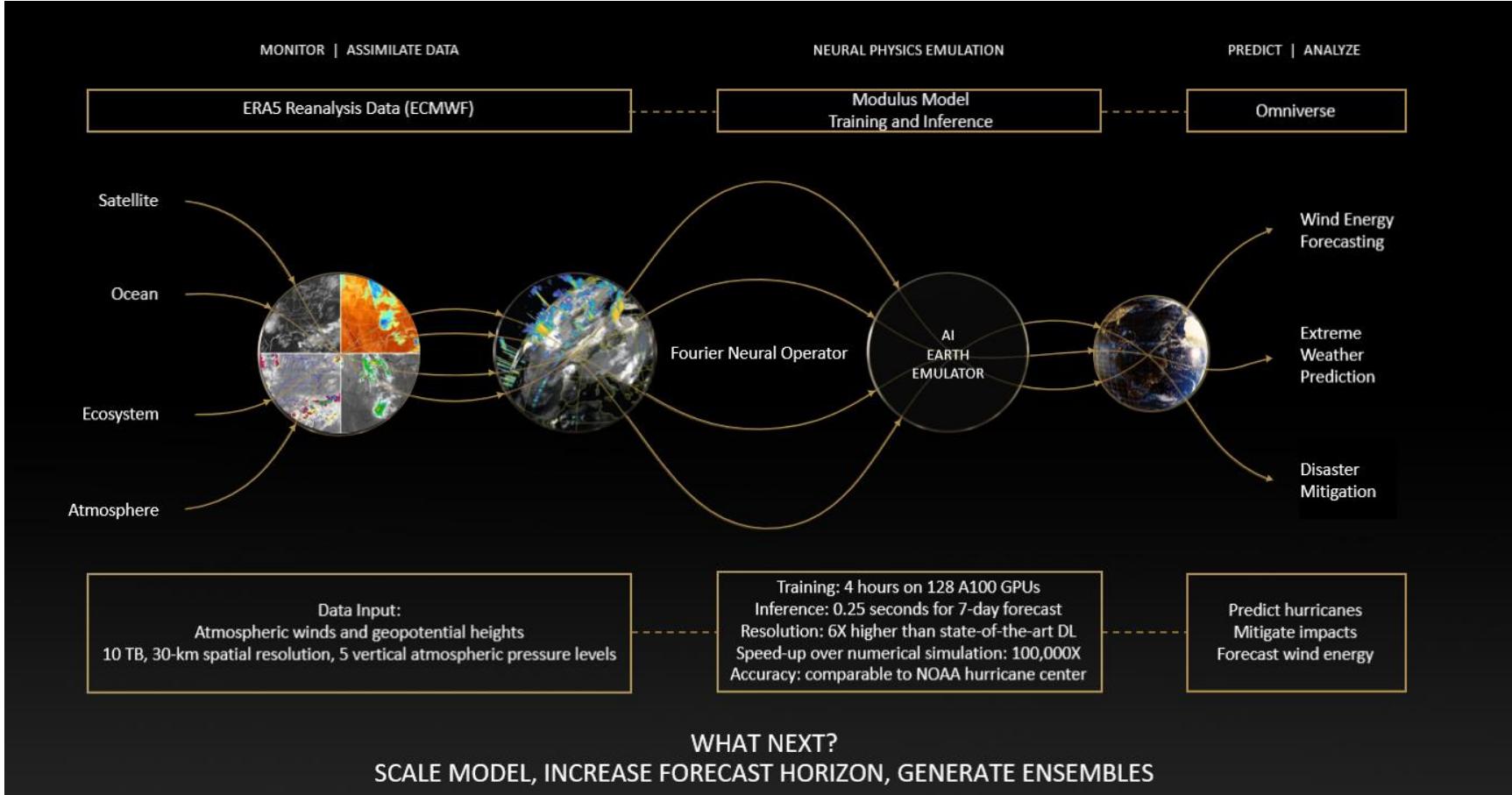


Commercial Solver



NVIDIA MODULUS FOR EARTH DIGITAL TWIN

Unprecedented Resolution, Speed & Accuracy enables Real-Time Prediction of Extremes



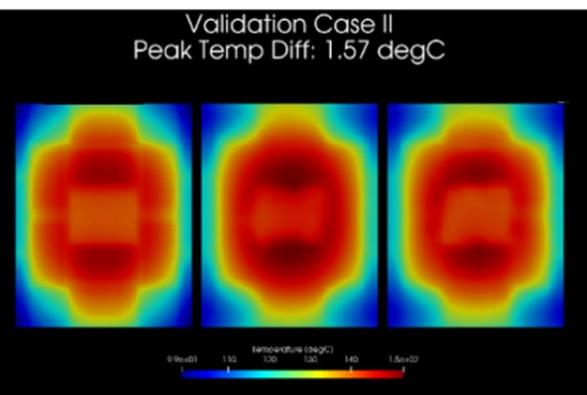
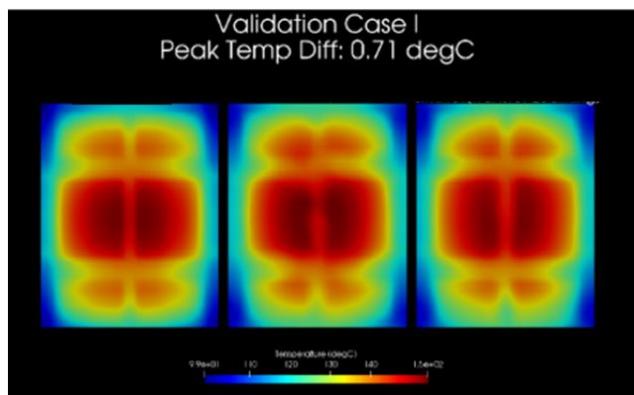
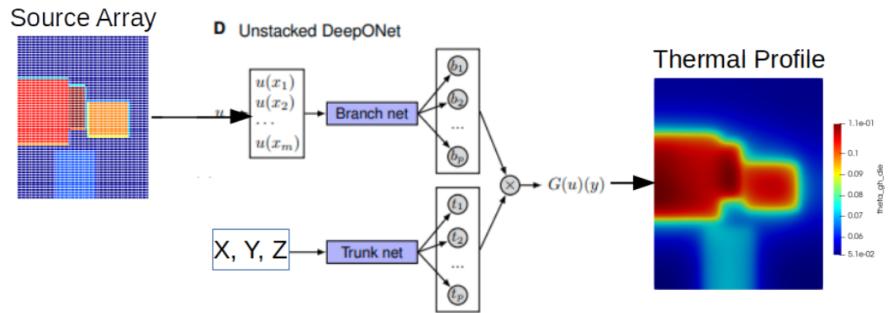
Design Optimization



NVIDIA GPU FLOOR PLANNING

Thermal Design

Floor Planning with DeepONet



Goals:

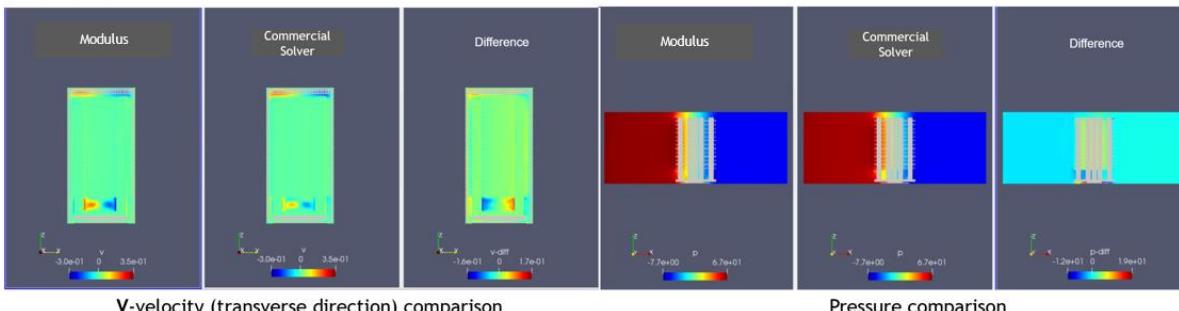
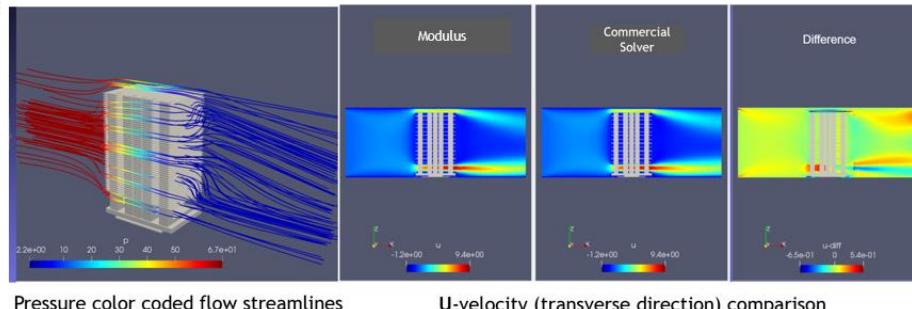
1. Instant Thermal Profile
2. Best Layout for Thermal Offset

NVIDIA DGX-A100 NVSWITCH HEAT SINK

Validation/Verification of single geometry results with CFD solvers



Nvidia DGX A100 Heatsink



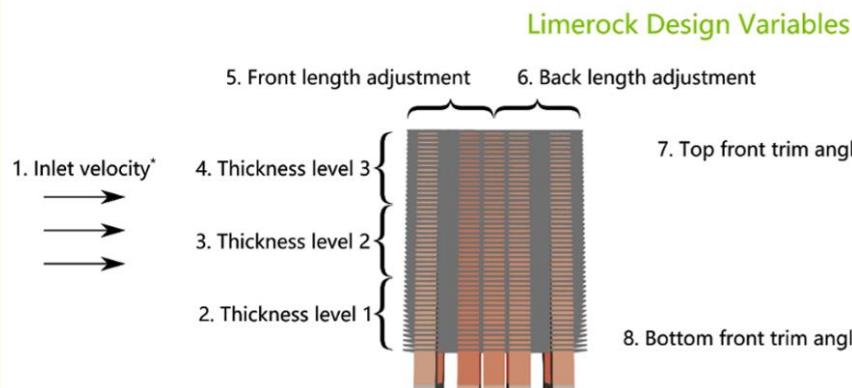
Mesh element size	Commercial solver pressure drop (Pa)	Modulus pressure drop (Pa)	Commercial solver mesh refinement results for NVSwitch pressure drop and peak temperature.			
			Absolute difference (%)	Commercial solver peak temperature (°C)	Modulus temperature (°C)	Absolute difference (%)
22.4 M	81.27	150.25	84.88	97.40	97.35	0.05
24.7 M	111.76	150.25	34.44	95.50	97.35	1.94
26.9 M	122.90	150.25	22.25	95.10	97.35	2.36
30.0 M	132.80	150.25	13.14	-	-	-
32.0 M	137.50	150.25	9.27	-	-	-

A comparison for the solver and SimNet results for NVSwitch pressure drop and peak temperature.

Property	OpenFOAM	Commercial Solver	Modulus
Pressure Drop (Pa)	133.96	137.50	150.25
Peak Temperature (°C)	93.41	95.10	97.35

PARAMETERIZED DGX-A100 NVSWITCH HEAT SINK

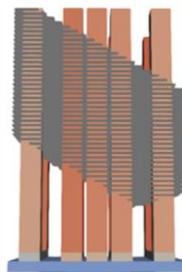
10,000x faster !!!



*Inlet velocity is not a design variable. It will be used for robust design optimization of Limerock in future.

Limerock Optimal Design

- 1. Inlet velocity: 5.7 m/s
- 2. Thickness level 1: 0.0031
- 3. Thickness level 2: 0.0044
- 4. Thickness level 3: 0.0030
- 5. Front length adjustment: -0.0124
- 6. Back length adjustment: 0.0025
- 7. Top front trim angle: 0.0223 rad
- 8. Bottom front trim angle: 0.5197 rad
- 9. Top back trim angle: 0.5147 rad
- 10. Bottom back trim angle: 0.2217 rad



Computational Times (10 parameters, 3 values per parameter)

Modulus (Training Time)	10,800 V100 GPU hrs.
Traditional Solver (OpenFOAM) 59,049 separate runs (26 wall hours on 12 CPU cores)	18.4 Million CPU hrs.

Improved Physics & Predictions



IMPROVED PREDICTIONS WITH MODULUS

Solution Accuracy Studies

Just channel with no heatsink

Mesh Size and details	Elements	Modulus P drop	Commercial Solver P drop	% diff.
Base mesh	8.5 M	4.45	3.80	17.04
1.3x refinement	14 M	4.45	3.88	14.64
2.7x refinement	23 M	4.45	3.89	14.36
1.2x refinement + Wall refinement	10 M	4.45	4.32	2.95
2.4x refinement + Wall refinement	20 M	4.45	4.40	1.23

FPGA heatsink

Mesh Size and details	Elements	Modulus P drop	Commercial Solver P drop	% diff.
Base mesh + Wall refinement	15 M	27.45	25.23	8.81
1.7x refinement + Wall refinement	25 M	27.45	26.16	4.94

FLOW & TRANSPORT IN A POROUS MEDIA

Stanford University (Cedric G. Fraces)

Buckley-Leverett Equation:

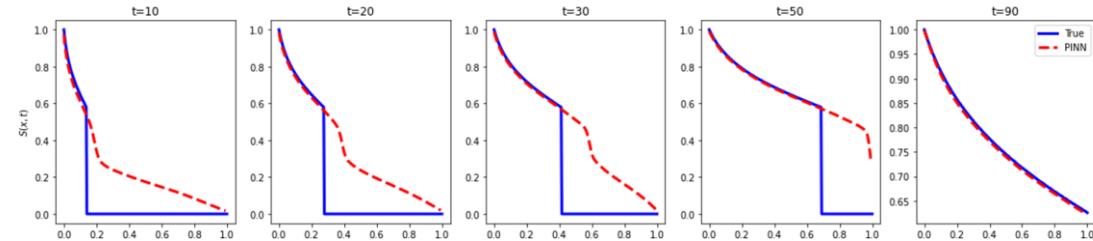
$$\frac{\partial S}{\partial t} + \frac{\partial f(S)}{\partial x} = 0$$

Where the fractional flow f is a nonlinear equation defined as:

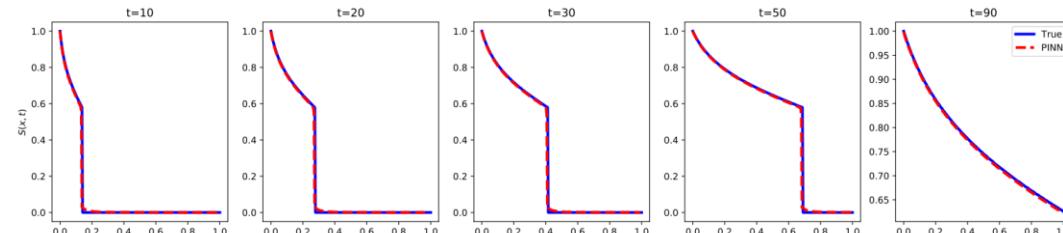
$$f(S) = \frac{(S - S_{wc})^2}{(S - S_{wc})^2 + (1 - S - S_{or})^2/M}$$

subject to constant boundary and initial conditions:

$$\begin{aligned} S(x = 0, t) &= S_{inj} \\ S(x, t = 0) &= S_{wc} \end{aligned}$$



Fuks & Tchelpli (PINNs)

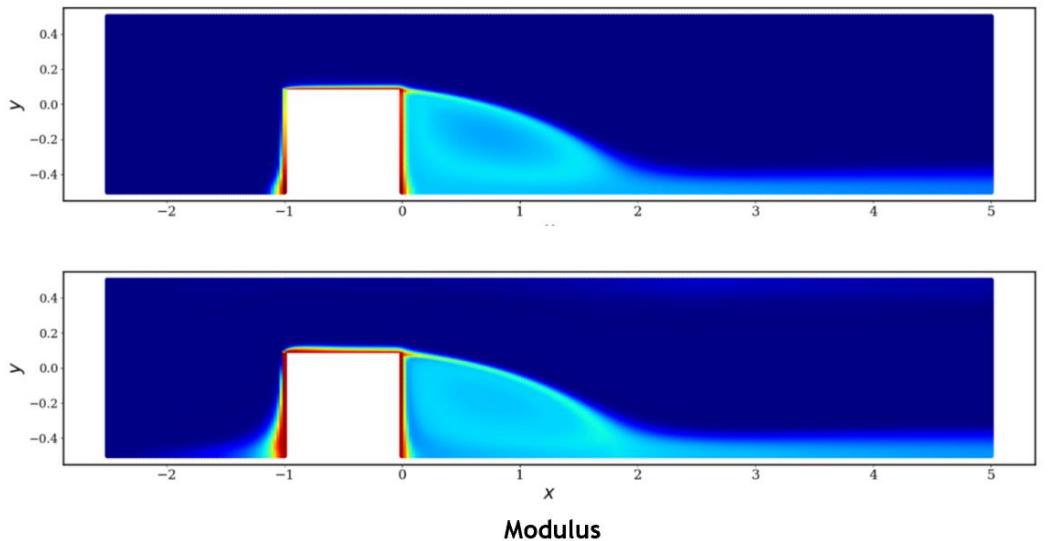


Gasm & Tchelpli (using Modulus)

MULTI-PHYSICS SIMULATION

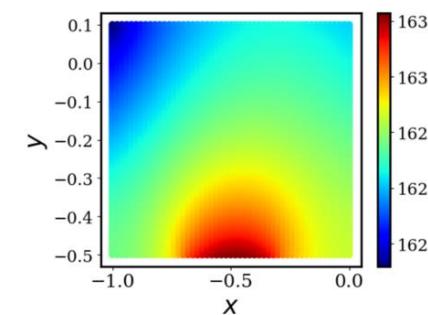
Conjugate Heat Transfer - No Training Data!

Commercial Solver

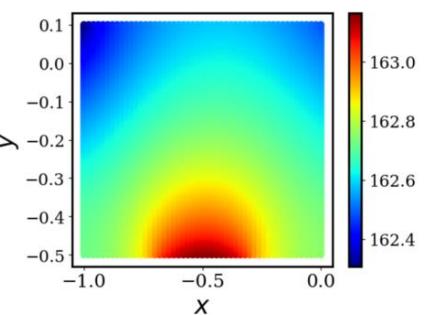


Fluid Temperature

Commercial Solver



Modulus



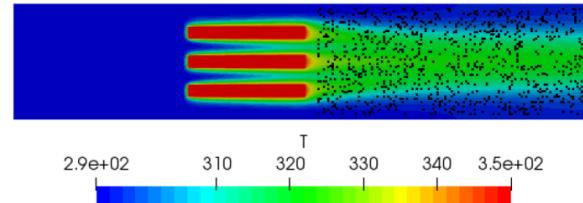
Solid Temperature

Inverse & Data Assimilation Problems



INVERSE PROBLEM

Finding Unknown Coefficients of a PDE: Heat Sink



Fluid Heat Convection:

$$0 = \nabla \cdot (D_{fluid} \nabla \theta_{fluid}) - \nabla \cdot (U \theta_{fluid}) \quad D_{fluid} = \frac{k_{fluid}}{\rho_{fluid} c_{pfluid}}$$

Solid Heat Conduction:

$$0 = \nabla \cdot (k_{solid} \nabla \theta_{solid}) \quad D_{solid} = \frac{k_{solid}}{\rho_{solid} c_{psolid}}$$

$$\theta_{solid} = \theta_{fluid}$$

Interface Conditions:

$$k_{solid}(N \cdot \nabla \theta_{solid}) = k_{fluid}(N \cdot \nabla \theta_{fluid})$$

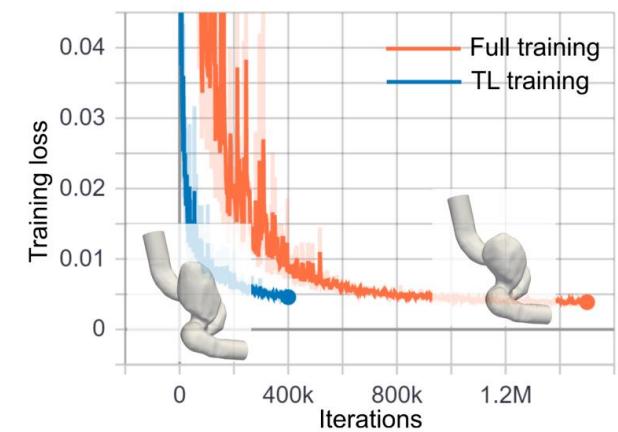
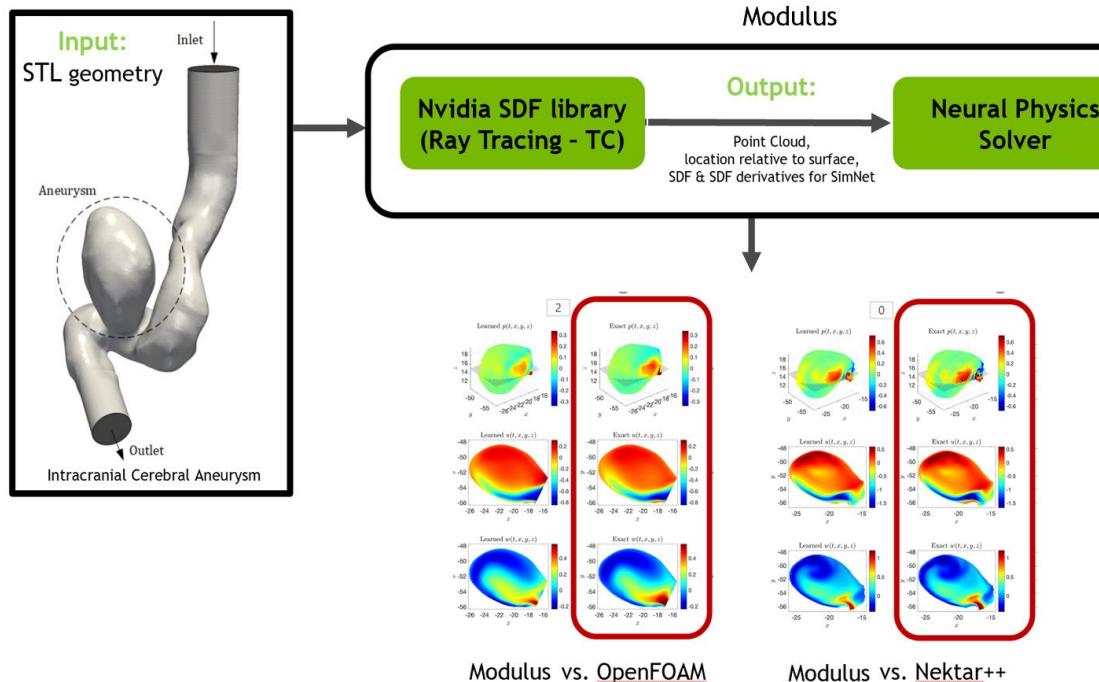
Results:

Property	OpenFOAM (True)	Modulus (Predicted)
Kinematic Viscosity (m^2/s)	1.00×10^{-2}	1.03×10^{-2}
Thermal Diffusivity (m^2/s)	2.00×10^{-3}	2.19×10^{-3}

SURGICAL PLANNING

Medical Imaging of an Intra-Cranial Aneurysm

https://www.youtube.com/watch?v=QjY_8xFjsgE

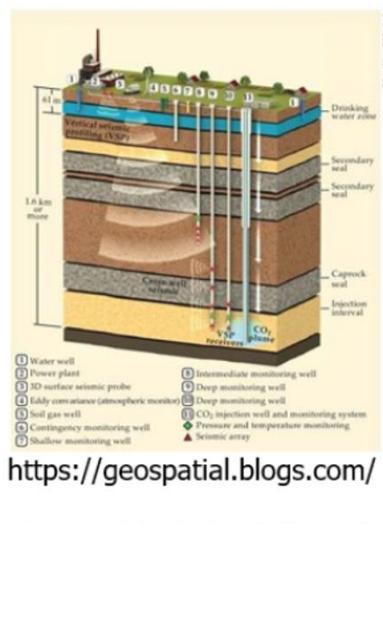


GEOPHYSICS APPLICATION

Seismic Wave Simulations

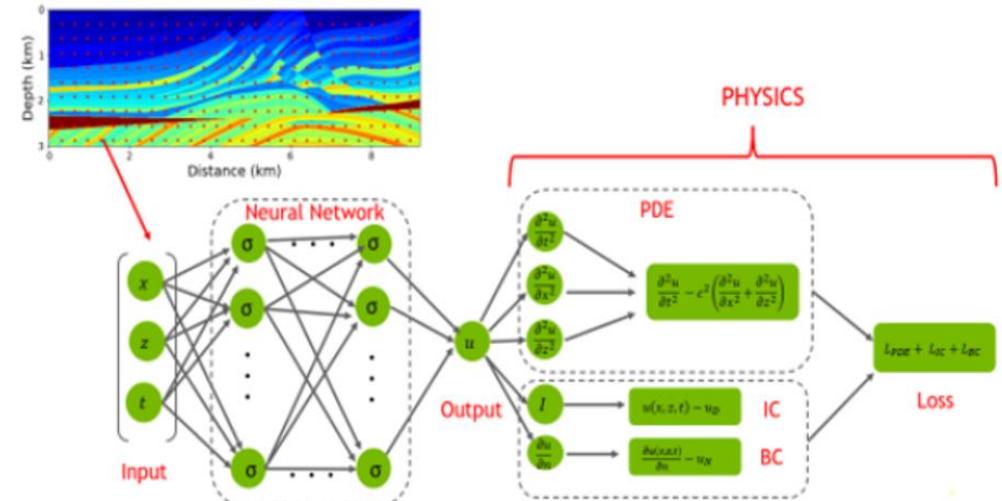
Seismic Imaging:

- An Intense sound source is directed into ground to evaluate subsurface conditions and contamination.
- Receivers called geophones , analogous to microphones, pickup echoes that come back from ground record the intensity and timing of these echoes on computers.
- The data collected is finally processed and turned into images of geologic structure (like MRI scan of brain)



<https://geospatial.blogs.com/>

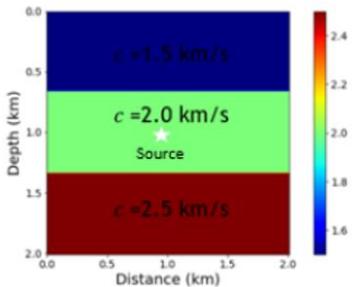
PINN Input : Point cloud representation of subsurface.
PINN Output : Seismic wave



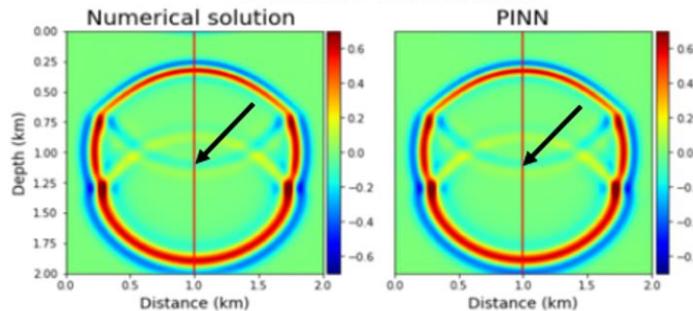
GEOPHYSICS APPLICATION

Seismic Wave Simulations

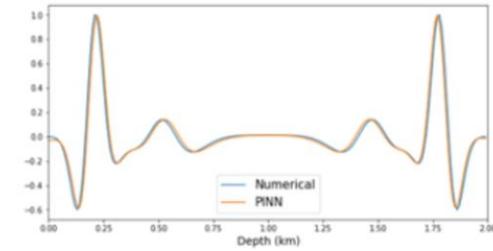
Subsurface model 1:



Seismic wavefields

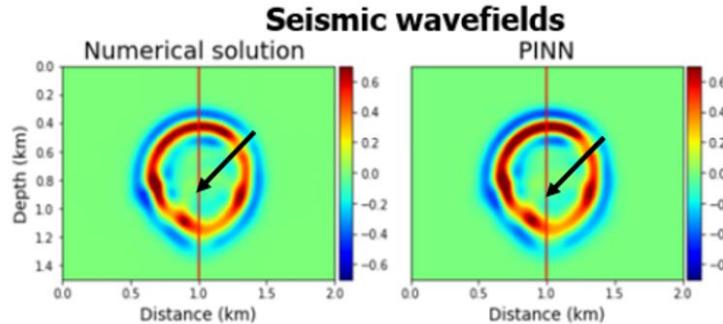


Closer look at the vertical red line:

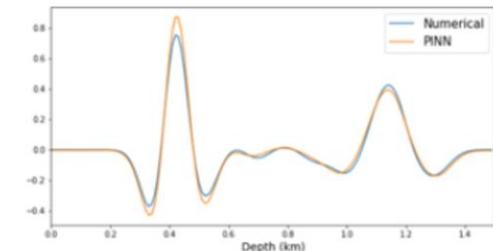


Subsurface model 2:

Source



Closer look at the vertical red line:



CONCLUSION

- Modulus - a framework for Physics based ML
<http://developer.nvidia.com/Modulus>
 - Release Notes
 - Installation Notes
 - User Guide
 - Theory
 - Examples
 - API Manual
 - Source Code
 - Example Data Sets
- Continued Development with 3-4 Releases/year
- Contributions from Scientific Community are welcome!